

## N and P-Channel Enhancement Mode Power MOSFET

#### Description

The NCE30NP07S uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

#### **General Features**

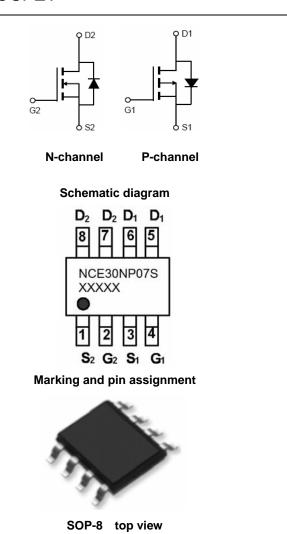
#### N-Channel

- $V_{DS}$  = 30V, $I_{D}$  =6.5A
- $R_{DS(ON)} < 24m\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 37m\Omega @ V_{GS}=4.5V$

#### P-Channel

$$\begin{split} V_{DS} &= -30 V, I_D = -7 A \\ R_{DS(ON)} &< 32 m \Omega @ V_{GS} = -10 V \\ R_{DS(ON)} &< 70 m \Omega @ V_{GS} = -4.5 V \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity	
NCE30NP07S	NCE30NP07S	SOP-8	Ø330mm	12mm	4000 units	
Above $M_{\text{restructure}} = N_{\text{restructure}} (T_{\text{restructure}} = restructure)$						

#### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parame	Symbol	N-Channel	P-Channel	Unit			
Drain-Source Voltage		V <sub>DS</sub>	30	-30	V		
Gate-Source Voltage		V <sub>GS</sub>	±20	±20	V		
Continuous Drain Current	T <sub>A</sub> =25℃		6.5	-7	А		
	T <sub>A</sub> =70℃	I <sub>D</sub>	5.4	-5.8	A		
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	30	-30	А		
Maximum Power Dissipation T <sub>A</sub> =25°C		P <sub>D</sub>	2.0	2.0	W		
Operating Junction and Storage T	$T_J, T_{STG}$	-55 To 150	-55 To 150	°C			
Thermal Characteristic							
Thermal Resistance, Junction-to-A	R <sub>0JA</sub>	N-Ch	62.5	°C/W			
Thermal Resistance, Junction-to-A	R <sub>eja</sub>	P-Ch	62.5	°C <b>/W</b>			



#### N-CH Electrical Characteristics (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	33	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1	1.6	3	V
Drain Course On State Desistence	P	$V_{GS}$ =10V, I <sub>D</sub> =6A	-	19	24	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	-	26	37	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =6A	15	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>		-	485.8	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, F=1.0MHz	-	65.2	-	PF
Reverse Transfer Capacitance	Crss		-	54	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	4.0	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =15V, R <sub>L</sub> =2.5 $\Omega$	-	2.0	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =3 $\Omega$	-	14.0	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	3.0	-	nS
Total Gate Charge	Qg		-	12.6	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15V, I_D = 6A,$	-	1.9	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	2.6	-	nC
Drain-Source Diode Characteristics	U		·	· · · · · ·		
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =6A	-	0.8	1.2	V



#### P-CH Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage BV <sub>DSS</sub>		V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V	-	-	-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)	····			•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.3	-1.65	-2.5	V
Drain Course On State Desistance	D	V <sub>GS</sub> =-10V, I <sub>D</sub> =-6.5A	-	28	32	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =-4.5V, I <sub>D</sub> =-6.5A	-	49	70	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-6.5A	10	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>		-	691.9	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, F=1.0MHz	-	113.7	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	109.4	-	PF
Switching Characteristics (Note 4)			-			
Turn-on Delay Time	t <sub>d(on)</sub>		-	7.5	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =-15V, R <sub>L</sub> =2.3 $\Omega$	-	5.5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10V, $R_{GEN}$ =6 $\Omega$	-	19	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	7	-	nS
Total Gate Charge	Qg		-	16.3	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-15V,I <sub>D</sub> =-6.5A V <sub>GS</sub> =-10V	-	2.2	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	VGS10V	-	4.1	-	nC
Drain-Source Diode Characteristics						•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-6.5A	_	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

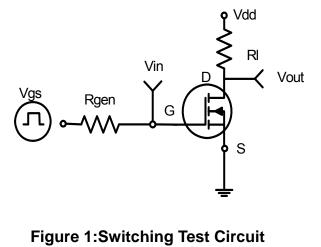
**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

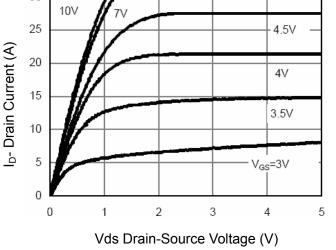
4. Guaranteed by design, not subject to production



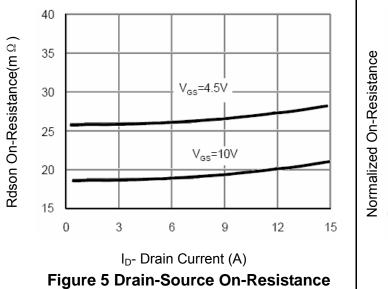
### N- Channel Typical Electrical and Thermal Characteristics (Curves)







**Figure 3 Output Characteristics** 



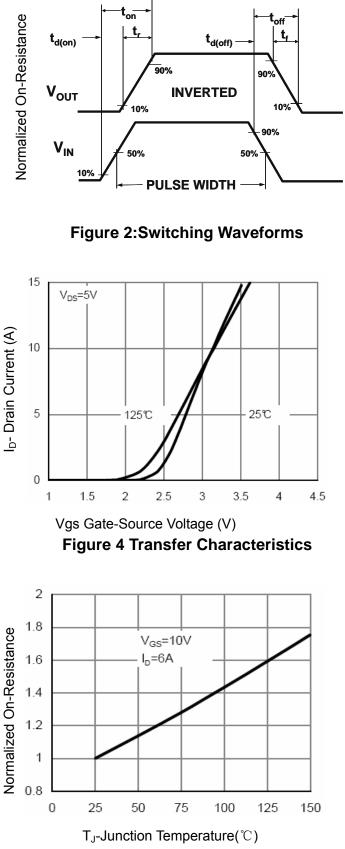
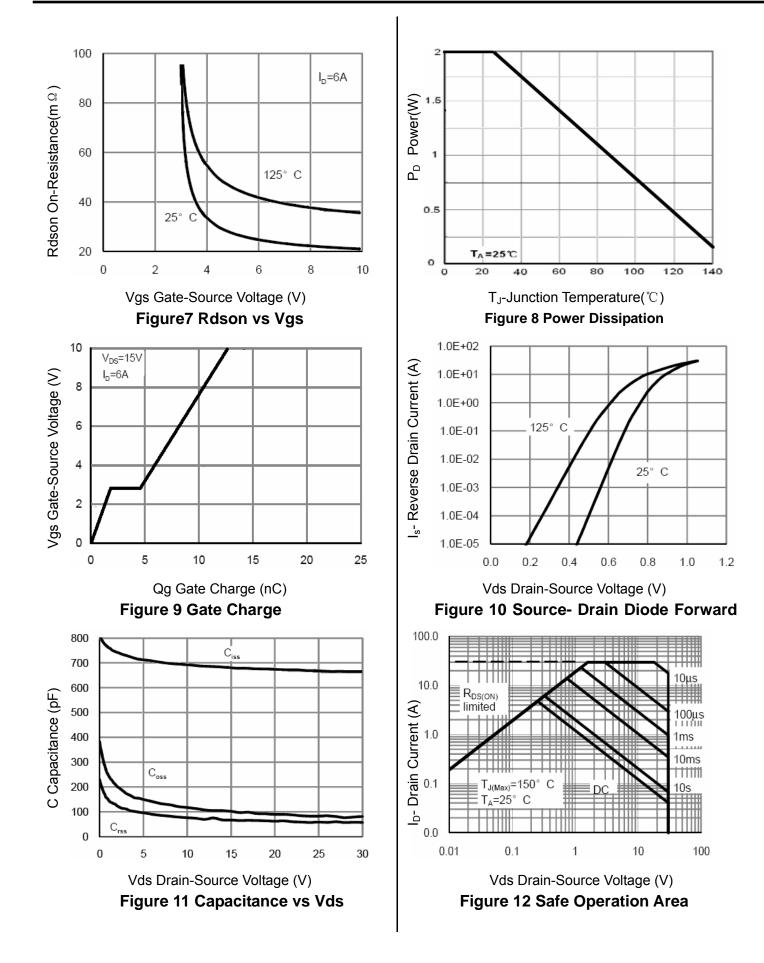


Figure 6 Drain-Source On-Resistance



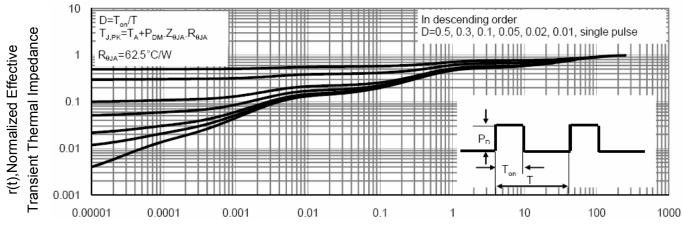
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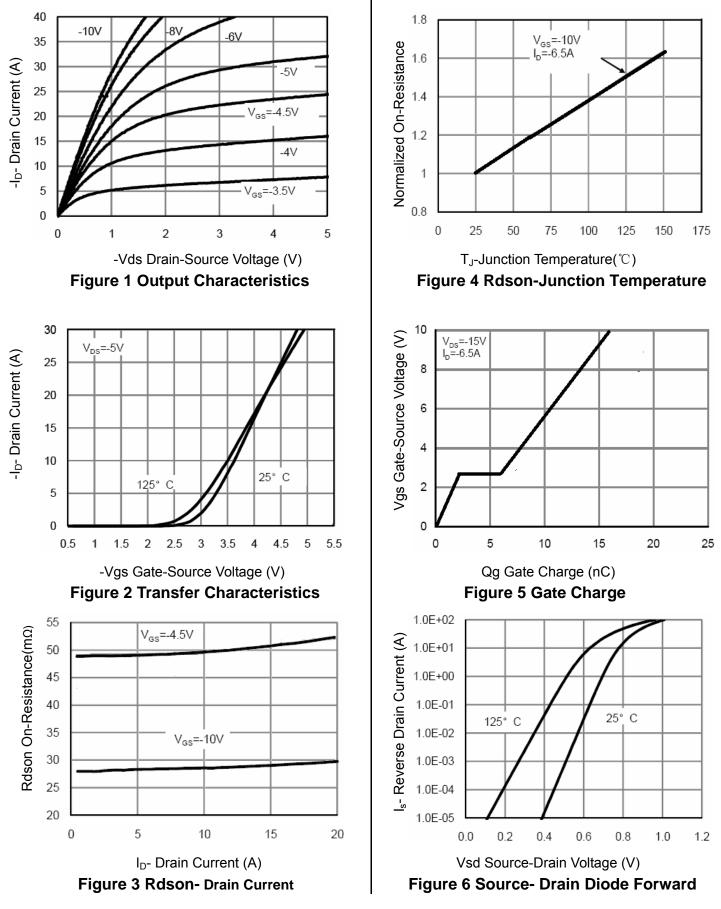
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Square Wave Pluse Duration(sec) Figure 13 Normalized Maximum Transient Thermal Impedance



### P- Channel Typical Electrical and Thermal Characteristics (Curves)





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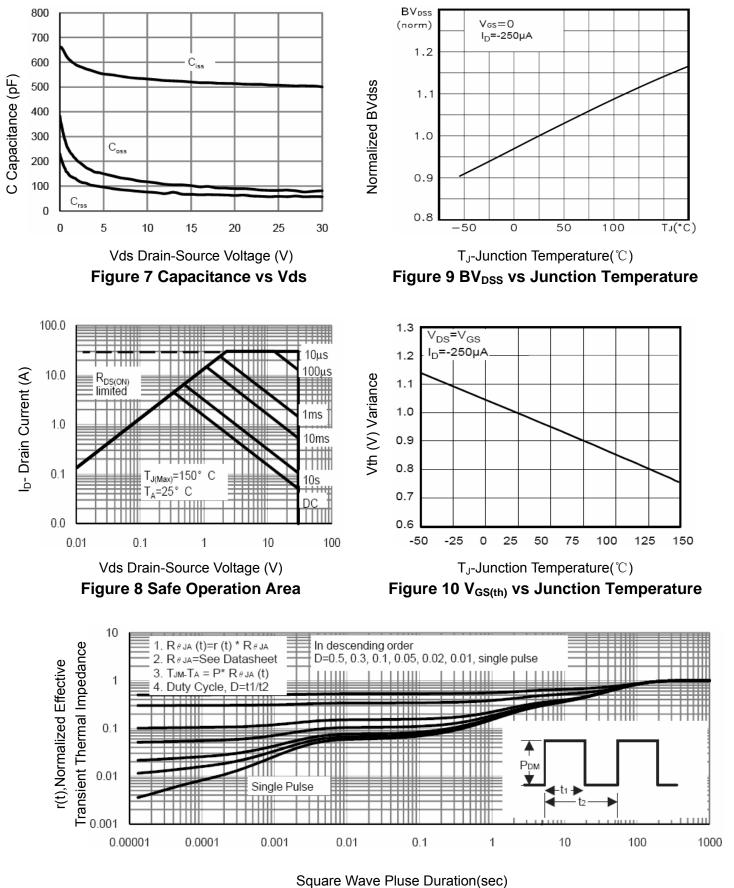
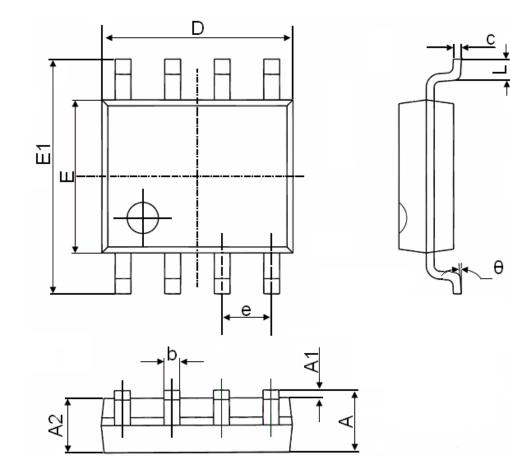


Figure 11 Normalized Maximum Transient Thermal Impedance



## SOP-8 Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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